

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74HC4051M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4051M96G3	SOIC	D	16	2500	330.0	16.8	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4051M96G4	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4051NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD74HC4051PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4051PWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4051PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4052M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4052M96G4	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4052NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD74HC4052PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4052PWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4052PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4053M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4053M96G3	SOIC	D	16	2500	330.0	16.8	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4053M96G4	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74HC4053NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD74HC4053PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4053PWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4053PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HCT4051M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HCT4052M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HCT4053M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HCT4053PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HCT4053PWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HCT4053PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD74HC4051M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4051M96G3	SOIC	D	16	2500	364.0	364.0	27.0
CD74HC4051M96G4	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4051NSR	SO	NS	16	2000	367.0	367.0	38.0
CD74HC4051PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4051PWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4051PWT	TSSOP	PW	16	250	356.0	356.0	35.0
CD74HC4052M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4052M96G4	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4052NSR	SO	NS	16	2000	356.0	356.0	35.0
CD74HC4052PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4052PWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4052PWT	TSSOP	PW	16	250	356.0	356.0	35.0
CD74HC4053M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4053M96G3	SOIC	D	16	2500	364.0	364.0	27.0
CD74HC4053M96G4	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4053NSR	SO	NS	16	2000	356.0	356.0	35.0
CD74HC4053PWR	TSSOP	PW	16	2000	356.0	356.0	35.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD74HC4053PWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4053PWT	TSSOP	PW	16	250	356.0	356.0	35.0
CD74HCT4051M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HCT4052M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HCT4053M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HCT4053PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HCT4053PWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HCT4053PWT	TSSOP	PW	16	250	356.0	356.0	35.0

**TUBE**


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD74HC4051E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4051E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4051EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4051EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4051M	D	SOIC	16	40	507	8	3940	4.32
CD74HC4051ME4	D	SOIC	16	40	507	8	3940	4.32
CD74HC4051NS	NS	SOP	16	50	530	10.5	4000	4.1
CD74HC4052E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4052E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4052M	D	SOIC	16	40	507	8	3940	4.32
CD74HC4052PW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD74HC4053E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4053E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4053M	D	SOIC	16	40	507	8	3940	4.32
CD74HC4053ME4	D	SOIC	16	40	507	8	3940	4.32
CD74HC4053MG4	D	SOIC	16	40	507	8	3940	4.32
CD74HC4053PW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD74HCT4051E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4051E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4051M	D	SOIC	16	40	507	8	3940	4.32
CD74HCT4051ME4	D	SOIC	16	40	507	8	3940	4.32
CD74HCT4051MG4	D	SOIC	16	40	507	8	3940	4.32
CD74HCT4052E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4052E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4052EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4052EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4052M	D	SOIC	16	40	507	8	3940	4.32
CD74HCT4053E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HCT4053E	N	PDIP	16	25	506	13.97	11230	4.32

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Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
CD74HCT4053M	D	SOIC	16	40	507	8	3940	4.32
CD74HCT4053ME4	D	SOIC	16	40	507	8	3940	4.32